



SPECIFICATION

Device Type	Top View LED
Model	CL-SF681DWW
Customer	

- Contents -

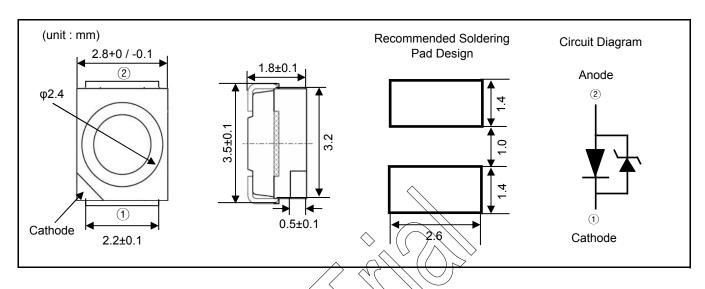
- 1. Outline Drawing And Dimension
- 2. Material Informations
- 3. Feature & Applications
- 4. Absolute Maximum Ratings
- 5. Initial Electrical/Optical Characteristics
- 6. Ranks
- 7. Chromaticity Coordinates Diagram
- 8. Characteristic Diagrams
- 9. Reliability
- 10. Solder Conditions
- 11. Taping
- 12. Packing Structure
- 13. Label Structure
- 14. Precaution For Use

lier	Customer
Approved by	Approved by

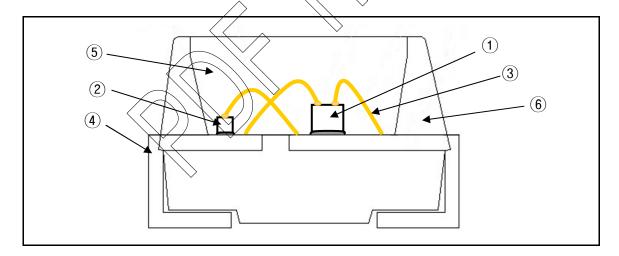




1. Outline Drawing And Dimension



2. Material Informations



Number	Item	Material
1	Chip	InGaN
2	Chip	Zener Diode
3	Wire	Gold Wire (Au 99.99%)
4	LeadFrame	Copper Frame (Silver Plated)
(5)	Encapsulating Resin	Silicone & Phosphor
6	PPA Cup	Heat -Resistant Polymer





3. Feature & Applications

♦ Feature

-. Package : SMD Top View Type

-. 3.5 × 2.8 × 1.8 (L × W × H) Small Size Device

-. Viewing Angle : $2\theta 1/2 = 120^{\circ}$

-. Colorless And Transparent Product

-. InGaN Chip

-. Long Time Reliability

-. ESD Protection

◆ Applications

- -. Automobile Dash Board Back Light
- -. Household Appliance Indicator
- -. Advertising/Corporate Identity/Signage Back Light
- -. Architectural Lighting Source
- -. Outdoor Linghting Source





4. Absolute Maximum Ratings

(Ta = 25 °C)

Items	Symbol	Absolute Maximum Ratings	Unit
Power Dissipation	Pb	108	mW
Forward Current	lf	30	mA
Pulse Forward Current	lfp	100	mA
Operating Temperature	Topr	-30 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +100	${\mathbb C}$
Coldoring Tomporature	т	Reflow Soldering : 260 ℃ for 10sec.	
Soldering Temperature	Tsld	Hand Soldering : 350 °C for 3sec.	

5. Initial Electrical/Optical Characteristics

(Ta = 25 °C)

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	VF	IF = 20mA	ı	3.2	3.6	V
Luminous Intensity	I۷	IF = 20mA	1000	-	2000	mcd
Reverse Voltage	VR	IR = 5mA	-	0.8	-	V
Viewing Angle	201/2	IF = 20mA	-	120	-	deg.

^{*} Luminous intensity measurement allowance is ± 10%.

Note: All mearsurements were made under standardized environment of IST

 $[\]divideontimes$ 01/2 : The off-axis where the luminous intensity is 1/2 of the peak intensity





1) Chromaticity Coordinates Rank

(Ta = 25 °C)

Rank A					
Χ	0.358	0.361	0.361	0.390	
Υ	0.361	0.385	0.412	0.382	
		Rank E	3		
Χ	0.390	0.399	0.439	0.426	
Υ	0.382	0.412	0.431	0.400	
		Rank C			
Х	0.426	0.439	0.497	0.477	Test
Υ	0.400	0.431	0.447	0.414	Condition
		Rank D			I _F =20mA
Χ	0.355	0.358	0.390	0.382	IF-ZUITA
Υ	0.341	0.361	0.382	0.358	
		Rank E			
Χ	0.382	0.390		· 0.413	
Υ	0.358	0.382	0.400	0.373	
	Rank F				
Χ	0.413	0.426	0.477	0.459	
Y	0.373	0.400	0.414	0.384	

^{*} The CIE(1931) standard colorimetric system.

2) Forward Voltage Rank

(Ta = 25 °C)

Rank	Test Condition	Min.	Тур.	Max.	Unit
0	IF = 20mA	2.9	-	3.1	
1	IF = 20mA	3.1	-	3.3	V
2	IF = 20mA	3.3	-	3.5	

 ^{★ 0.05}V tolerance for the forward voltage may be caused by measurement inaccuracy.

3) Luminous Intensity Rank

(Ta = 25 °C)

Rank	Test Condition	Min.	Тур.	Max.	Unit
Α	IF = 20mA	1000	-	1500	mod
В	IF = 20mA	1500	-	2000	mcd

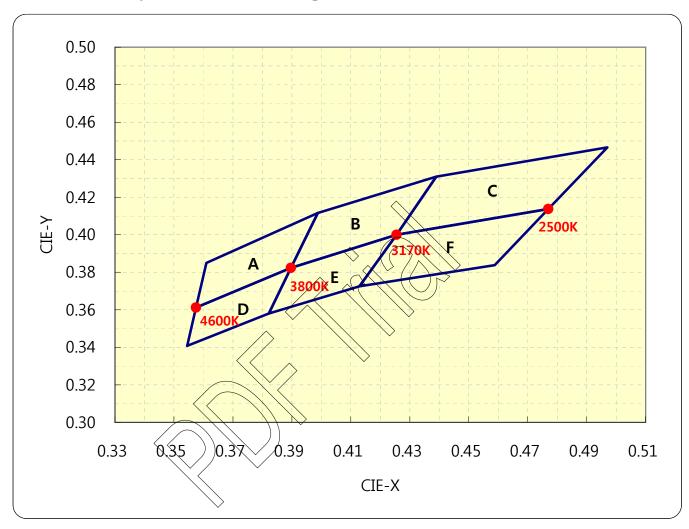
Luminous intensity measurement allowance is ± 10%

Measurement uncertainty of the color coordinates: ± 0.01





7. Chromaticity Coordinates Diagram

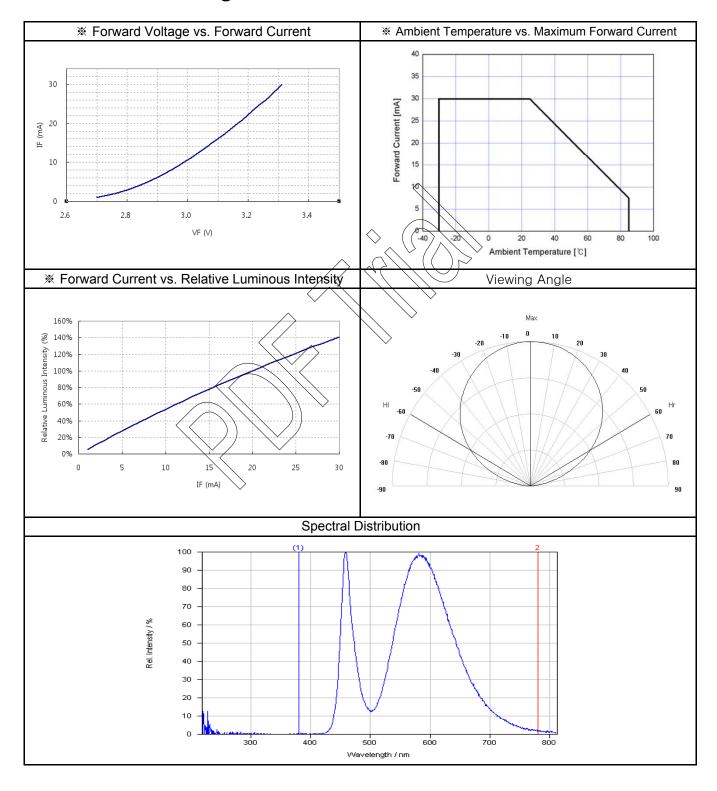


Measurement uncertainty of the Correlated Color Temperature : ± 3%





8. Characteristic Diagrams







9. Reliability

1) Test Items and Results

Test Item	Test Conditions	Note (Hours/Cycles)	Number of Damaged
High Temperature Storage	Ta = 100 ℃	1000 Hours	0/22
Low Temperature Storage	Ta = -40 °C	1000 Hours	0/22
High Temperature High Humidity Storage	Ta = 60 °C, RH = 90%	1000 Hours	0/22
Temperature Cycle	-40 °C ~ 25 °C ~ 100 °C ~ 25 °C 30min 5min 30min 5min	100 Cycles	0/22
Resistance to Soldering Heat (Reflow Soldering)	Tsid = 260°C, 10sec (Pre Treatment 30°C, 70%, 168Hrs)	2 times	0/22
Solderability (Reflow Soldering)	Tsld = 215±5℃, 3sec (Using Flux, Lead Solder)	1 time (over 95%)	0/22
*3 Room Temperature Life Test	25℃, I _F = 40mA	1000 Hours	0/22
*3 High Temperature Life Test	Ta = 85 ℃, I _F = 10mA	1000 Hours	0/22
*³ High Temperature High Humidity Life Test	Ta = 60 ℃, RH = 90%, I _F = 24mA	1000 Hours	0/22
*3 Low Temperature Life Test	Ta = -30 ℃, I _F = 40mA	1000 Hours	0/22

2) Criteria for Judging the Damage

Item	Symbol	Test Condition	Lir	mit
Item	Syllibol	rest Condition	Min.	Max.
Forward Voltage	VF	IF = 40mA	-	*1 U.S.L × 1.1
Luminous Intensity (1)	lv	IF = 40mA	*2 L.S.L × 0.7	-
Luminous Intensity (2)	lv	IF = 40mA	*2 L.S.L × 0.5	-

^{*1} U.S.L = Upper Standard Level

^{*2} L.S.L = Lower Standard Level

^{*3} These test items are judged by the criteria of Luminius Intensity (2).

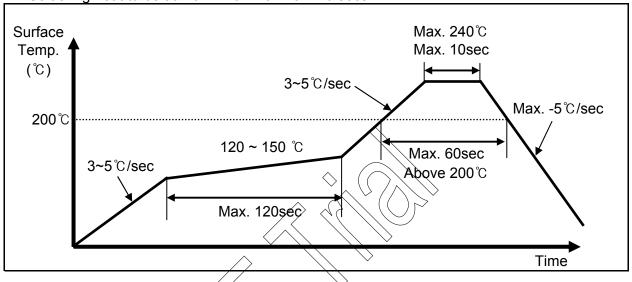




10. Solder Conditions

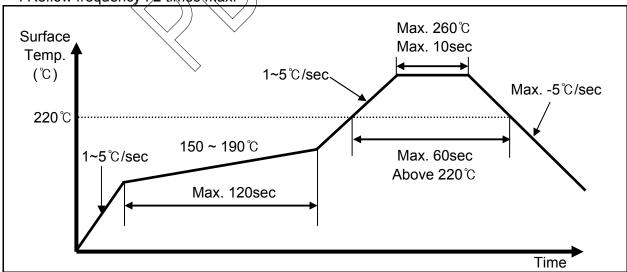
1) Reflow Conditions (Lead Solder)

- -. Preliminary heat to be at Max. 200 °C for Max. 2 mins.
- -. Soldering heat to be at Max. 240 °C for Max. 10 secs.



2) Reflow Conditions (Pb Free)

- -. Preliminary heat to be at Max. 220 % for Max. 2 mins.
- -. Soldering heat to be at Max. 260 % for Max. 10 secs.
- -. Reflow frequency: 2 times max.



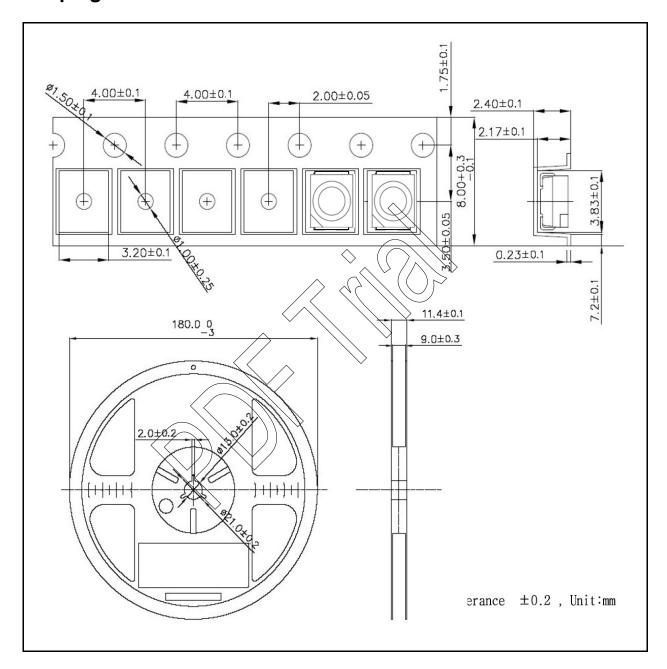
3) Hand Soldering Conditions

-. Not more than 3 seconds at 350 °C, under soldering iron. (One time Only)





11. Taping



- 1) Quantity: The quantity/Reel to be 2,000pcs.
- 2) Cumulative Tolerance: Cumulative Tolerance/10 pitches to be ±0.2mm
- 3) Adhesion Strength of Cover Tape: Adhesion strength to be 0.1~0.7N when the cover tape is turned off from the carrier tape at 10° angle to be the carrier tape.
- 4) Packing: P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof package.





12. Precaution For Use

1) Storage

In order to avoid the absorption of moisture, it is recommended to store in a dry box (or a desiccator) with a desiccant. Otherwise, to store them in the following environment is recommended.

Temperature : 5 °C ~ 30 °C Humidity : maxim 65%RH

2) Attention after open.

LED is correspond to SMD, when LED be soldered dip, interfacial separation may affect the light transmission effciency, causing the light intensity to drop. Attention in followed;

- a. After opened and mounted the soldering shall be quickly.
- b. Keeping of a fraction

Temperature : 5 ~ 40 ℃ Humidity : less than 30%

- 3) It is recommended that user should complete the use of the whole pakage which 48 hours upon unsealing. In the event of incomplete usage, It is advised that user preheat the remaining devices at 60±5 °C for 10-12hours pior to use.
- 4) Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.
- 5) Quick cooling shall be avoided.
- 6) Components shall not be mounted on wraped direction of PCB.
- 7) Anti radioactive ray design is not considered for the products.
- 8) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When washing is required, IPA should be used.
- 9) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.
- 10) LEDs must be stored to maintain a clean atmosphere.
 If the LEDs are stored for 3months or more after being shipped from IST, a sealed container with a nitrogen atmosphere should be used for storage.
- 11) The LEDs must be used within one day after opening the moisture proof packing. Repack unused products with anti-moisture packing, fold to close any opening and then store in a dry place.
- 12) Repack unused products with one day after opening the moisture-proof packing.
- 13) The appearance and specifications of the product may be modified for improvement without notice.

•